05-17-2005

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PATENTS ONLY		
	e record the attached documents or the new address(es) below.	
l. Name of conveying party(ies)	2. Name and address of receiving party(ies)	
Jae Suk LEE	Name:DongbuAnam Semiconductor Inc.	
	Internal Address:	
Additional name(s) of conveying party(ies) attached? Yes 🗸 No		
B. Nature of conveyance/Execution Date(s): Execution Date(s) 05-10-2005	Street Address: 891-10, Daechi-dong, Kangnam-gu	
✓ Assignment Merger	City: Seoul	
Security Agreement Change of Name Joint Research Agreement	State:	
Government Interest Assignment Executive Order 9424, Confirmatory License	Country: KOREA Zip: 135-280	
Other	Additional name(s) & address(es) attached? ☐ Yes ✔ No	
A. Patent Application No.(s) EAYALEN1 00000021 11126900 40.00 0P	document is being filed together with a new application. B. Patent No.(s) ached? Yes No	
5. Name and address to whom correspondence concerning document should be mailed: 6. Total number of applications and patents involved: 1		
Name: Andrew D. Fortney, Ph.D.	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.	
Internal Address: The Law Offices of Andrew D. Fortney, Ph.D., P.C.	Authorized to be charged by credit card Authorized to be charged to deposit account	
Street Address: 7257 N. Maple Ave., Suite 107	Enclosed None required (government interest not affecting title)	
City:	8. Payment Information	
State: CA Zip: 93720	a. Credit Card Last 4 Numbers1447 Expiration Date02/08	
Phone Number: 559-299-0128	b. Deposit Account Number	
Fax Number: 559-299-0118	Authorized User Name	
Email Address: drew@fortneylaw.com		
9. Signature: Signature	05-10-2005 Date	
Signature	Dale	

Documents to be recorded (including cover sheet) should be faxed to (703) 306-5995, or mailed to: Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

Andrew D. Fortney, Ph.D.

Name of Person Signing

PATENT

Total number of pages including cover

sheet, attachments, and documents:

REEL: 016560 FRAME: 0934

2

___, a corporation

Attorney Docket No.: PPW05-004DS

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned,

Do hereby sell, assign and transfer to **DongbuAnam Semiconductor Inc.**

Jae Suk LEE

who have created a certain invention for which an application for United States Letters Patent was executed by me concurrently herewith and entitled:

Method of Forming Pre-Metal Dielectric Layer

of Republic of Korca	, having a place of business				
at 891-10, Daechi-dong, Kangnam-gu, Seoul, 135-280	, its successors, assigns, and				
legal representatives, the full and exclusive right to said invention and said application and to any and all					
inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filled in the United States, its territorial possessions and/or any					
			foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties;		
			unions, agreements, acts, and treaties, including an inture conventions, t	inions, agreements, acts, and treaties;	
			Agree that DongbuAnam Semiconductor Inc. hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as said invention, in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives; and		
				•	
Covenant with said Assignee, its successors, assigns, or legal repr mortgage, license or other agreement affecting the rights and property h by the undersigned, and that full right to convey the same as herein expr	erein conveyed has been made to others				
IN TESTIMONY WHEREOF I have hereunto set MY signature on the date indicated below.					
Full Name of Sole/First Inventor:					
Jae Suk LEE					
Inventor's Signature:	Date: Month/Day/Year				
Juesuk Lee	5/10/2005				
Full Name of Second Inventor, if any:					
Inventor's Signature:	Date: Month/Day/Year				

Customer No. 36872

RECORDED: 05/10/2005

PATENT REEL: 016560 FRAME: 0935